

# CAS310M17BM3

1700 V, 310 A, Silicon Carbide, Half-Bridge Module

|                       |               |
|-----------------------|---------------|
| <b>V<sub>DS</sub></b> | <b>1700 V</b> |
| <b>I<sub>DS</sub></b> | <b>310 A</b>  |

## Technical Features

- Industry Standard 62 mm Footprint
- Ultra Low Loss, High-Frequency Operation
- Zero Reverse Recovery from Diodes
- Zero Turn-off Tail Current from MOSFET
- Normally-off, Fail-safe Device Operation
- Copper Baseplate and Aluminum Nitride Insulator



## Typical Applications

- Induction Heating
- Motor Drives
- Renewables
- Railway Auxiliary & Traction
- EV Fast Charging
- UPS and SMPS

## System Benefits

- 62 mm Form Factor Enables System Retrofit
- Increased System Efficiency, due to Low Switching & Conduction Losses of SiC

## Key Parameters

| Parameter                                | Symbol               | Min. | Typ.   | Max. | Unit | Conditions  | Note                  |
|--|----------------------|------|--------|------|------|---|-----------------------|
| Drain-Source Voltage                     | V <sub>DS</sub>      |      |        | 1700 | V    |   |                       |
| Gate-Source Voltage, Maximum Value       | V <sub>GS(max)</sub> | -8   |        | +19  |      | Transient   | Note 1<br>Fig. 33     |
| Gate-Source Voltage, Recommended         | V <sub>GS(op)</sub>  |      | -4/+15 |      |      | Static  |                       |
| DC Continuous Drain Current              | I <sub>D</sub>       |      | 409    |      | A    | V <sub>GS</sub> = 15 V, T <sub>C</sub> = 25 °C, T <sub>VJ</sub> ≤ 175 °C                          | Notes 2, 3<br>Fig. 21 |
|  |                      |      | 307    |      |      | V <sub>GS</sub> = 15 V, T <sub>C</sub> = 90 °C, T <sub>VJ</sub> ≤ 175 °C                          |                       |
| DC Source-Drain Current (Schottky Diode) | I <sub>SD(SD)</sub>  |      | 482    |      |      | V <sub>GS</sub> = -4 V, T <sub>C</sub> = 25 °C, T <sub>VJ</sub> ≤ 175 °C                          |                       |
| Pulsed Drain-Source Current              | I <sub>DM</sub>      |      | 620    |      |      | t <sub>pmax</sub> limited by T <sub>VJmax</sub><br>V <sub>GS</sub> = 15 V, T <sub>C</sub> = 25 °C |                       |
| Power Dissipation                        | P <sub>D</sub>       |      | 1630   |      | W    | T <sub>C</sub> = 25 °C, T <sub>VJ</sub> ≤ 175 °C  | Note 4<br>Fig. 21     |
| Virtual Junction Temperature             | T <sub>VJ(op)</sub>  | -40  |        | 150  | °C   | Operation   |                       |
|  |                      |      |        | 175  |      | Intermittent with Reduced Life  |                       |

Note (1): Recommended turn-on gate voltage is 15 V with ±5 % regulation tolerance

Note (2): Current limit calculated by  $I_{D(max)} = \sqrt{(P_D/R_{DS(typ)})(T_{VJ(max)}, I_{D(max)})}$

Note (3): Verified by design

Note (4):  $P_D = (T_{VJ} - T_C)/R_{TH(JC,typ)}$

MOSFET Characteristics (Per Position) ( $T_{VJ} = 25^\circ\text{C}$  Unless Otherwise Specified)

| Parameter  | Symbol              | Min. | Typ.              | Max. | Unit                      | Conditions  | Note                 |
|--|---------------------|------|-------------------|------|---------------------------|---|----------------------|
| Drain-Source Breakdown Voltage   | $V_{(BR)DSS}$       | 1700 |                   |      | V                         | $V_{GS} = 0\text{ V}, T_{VJ} = -40^\circ\text{C}$   |                      |
| Gate Threshold Voltage   | $V_{GS(\text{th})}$ | 1.8  | 2.5               | 3.6  |                           | $V_{DS} = V_{GS}, I_D = 102\text{ mA}$  |                      |
|  |                     |      | 2.0               |      |                           | $V_{DS} = V_{GS}, I_D = 102\text{ mA}, T_{VJ} = 175^\circ\text{C}$  |                      |
| Zero Gate Voltage Drain Current  | $I_{DSS}$           |      | 26.4              | 2560 | $\mu\text{A}$             | $V_{GS} = 0\text{ V}, V_{DS} = 1700\text{ V}$   |                      |
| Gate-Source Leakage Current  | $I_{GSS}$           |      | 4                 | 1000 | $\text{nA}$               | $V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$   |                      |
| Drain-Source On-State Resistance (Devices Only)  | $R_{DS(\text{on})}$ |      | 4.3               | 5.8  | $\text{m}\Omega$          | $V_{GS} = 15\text{ V}, I_D = 310\text{ A}$  | Fig. 2<br>Fig. 3     |
|  |                     |      | 8.4               |      |                           | $V_{GS} = 15\text{ V}, I_D = 310\text{ A}, T_{VJ} = 150^\circ\text{C}$  |                      |
|  |                     |      | 9.8               |      |                           | $V_{GS} = 15\text{ V}, I_D = 310\text{ A}, T_{VJ} = 175^\circ\text{C}$  |                      |
| Transconductance   | $g_{fs}$            |      | 290               |      | S                         | $V_{DS} = 20\text{ V}, I_D = 310\text{ A}$  | Fig. 4               |
|  |                     |      | 284               |      |                           | $V_{DS} = 20\text{ V}, I_D = 310\text{ A}, T_{VJ} = 150^\circ\text{C}$  |                      |
| Turn-On Switching Energy, $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$<br>$T_{VJ} = 150^\circ\text{C}$  | $E_{On}$            |      | 4.4<br>4.1<br>4.0 |      | mJ                        | $V_{DD} = 900\text{ V},$<br>$I_D = 310\text{ A},$<br>$V_{GS} = -4\text{ V}/15\text{ V},$<br>$R_{G(\text{OFF})} = 1.0\ \Omega, R_{G(\text{ON})} = 1.0\ \Omega,$<br>$L = 13.6\ \mu\text{H}$ | Fig. 11<br>Fig. 13   |
| Turn-Off Switching Energy, $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$<br>$T_{VJ} = 150^\circ\text{C}$ | $E_{Off}$           |      | 7.2<br>7.4<br>7.4 |      |                           |   |                      |
| Internal Gate Resistance   | $R_{G(\text{int})}$ |      | 1.85              |      |                           | $\Omega$  | $f = 100\text{ kHz}$ |
| Input Capacitance  | $C_{iss}$           |      | 31.5              |      | nF                        | $V_{GS} = 0\text{ V}, V_{DS} = 1000\text{ V},$<br>$V_{AC} = 25\text{ mV}, f = 100\text{ kHz}$   | Fig. 9               |
| Output Capacitance   | $C_{oss}$           |      | 1.8               |      |                           |   |                      |
| Reverse Transfer Capacitance   | $C_{rss}$           |      | 45                |      | pF                        |   |                      |
| Gate to Source Charge  | $Q_{GS}$            |      | 320               |      | nC                        | $V_{DS} = 1200\text{ V}, V_{GS} = -4\text{ V}/15\text{ V},$<br>$I_D = 310\text{ A},$<br>Per IEC60747-8-4 pg 21  |                      |
| Gate to Drain Charge   | $Q_{GD}$            |      | 280               |      |                           |   |                      |
| Total Gate Charge  | $Q_G$               |      | 996               |      |                           |   |                      |
| FET Thermal Resistance, Junction to Case   | $R_{th\text{JC}}$   |      | 0.092             |      | $^\circ\text{C}/\text{W}$ |   | Fig. 17              |

Diode Characteristics (Per Position) ( $T_{VJ} = 25^\circ\text{C}$  Unless Otherwise Specified)

| Parameter  | Symbol            | Min. | Typ.              | Max. | Unit                      | Conditions  | Note              |
|--|-------------------|------|-------------------|------|---------------------------|---|-------------------|
| Diode Forward Voltage  | $V_F$             |      | 1.78              |      | V                         | $V_{GS} = -4\text{ V}, I_F = 310\text{ A}, T_{VJ} = 25^\circ\text{C}$   | Fig. 7            |
|  |                   |      | 2.50              |      |                           | $V_{GS} = -4\text{ V}, I_F = 310\text{ A}, T_{VJ} = 150^\circ\text{C}$  |                   |
| Reverse Recovery Time  | $t_{rr}$          |      | 27                |      | ns                        |   |                   |
| Reverse Recovery Charge  | $Q_{rr}$          |      | 4.5               |      | $\mu\text{C}$             | $V_{GS} = -4\text{ V}, I_{SD} = 310\text{ A}, V_R = 900\text{ V}$<br>$di/dt = 26.5\text{ A}/\text{ns}, T_{VJ} = 150^\circ\text{C}$              | Fig. 32           |
| Peak Reverse Recovery Current  | $I_{rrm}$         |      | 281               |      | A                         |   |                   |
| Reverse Recovery Energy, $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$<br>$T_{VJ} = 150^\circ\text{C}$ | $E_{rr}$          |      | 3.5<br>3.8<br>3.9 |      | mJ                        | $V_{DS} = 900\text{ V}, I_D = 310\text{ A},$<br>$V_{GS} = -4\text{ V}/15\text{ V}, R_{G(\text{ext})} = 1.0\ \Omega,$<br>$L = 13.6\ \mu\text{H}$ | Fig. 14<br>Note 5 |
| Diode Thermal Resistance, JCT. to Case   | $R_{th\text{JC}}$ |      | 0.086             |      | $^\circ\text{C}/\text{W}$ |   | Fig. 18           |

Note (5): SiC Schottky diodes do not have reverse recovery energy but still contribute capacitive energy

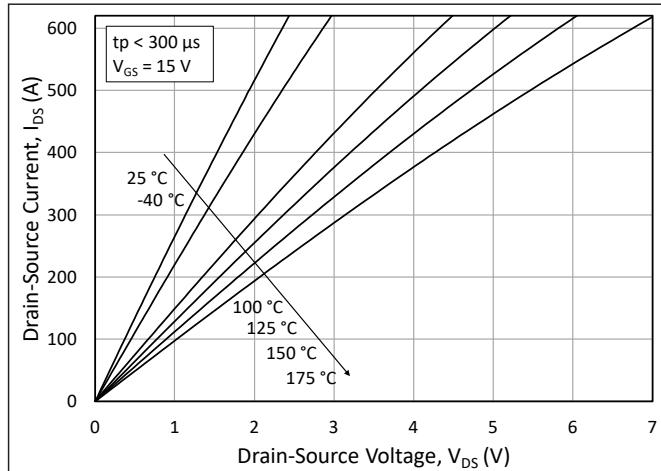


## Module Physical Characteristics

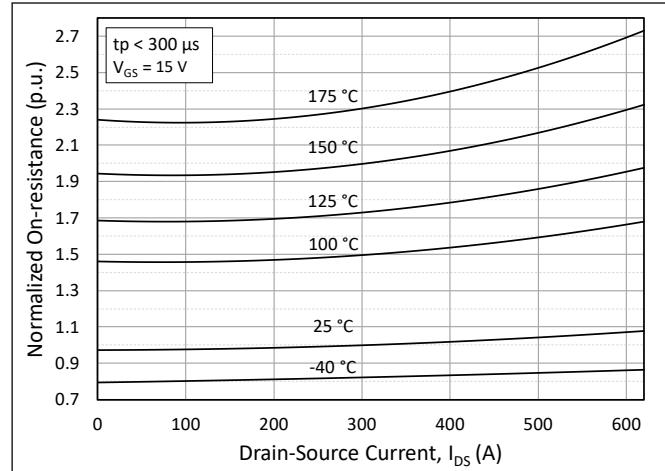
| Parameter                          | Symbol             | Min. | Typ. | Max. | Unit                    | Conditions  |  |
|------------------------------------|--------------------|------|------|------|-------------------------|---|--|
| Package Resistance, M1 (High-Side) | $R_{3-1}$          |      | 1.31 |      | $\text{m}\Omega$        | $T_C = 25^\circ\text{C}, I_{SD} = 310 \text{ A, Note 6}$  |  |
|                                    |                    |      | 1.84 |      |                         | $T_C = 125^\circ\text{C}, I_{SD} = 310 \text{ A, Note 6}$ |  |
| Package Resistance, M2 (Low-Side)  | $R_{1-2}$          |      | 1.26 |      |                         | $T_C = 25^\circ\text{C}, I_{SD} = 310 \text{ A, Note 6}$  |  |
|                                    |                    |      | 1.77 |      |                         | $T_C = 125^\circ\text{C}, I_{SD} = 310 \text{ A, Note 6}$ |  |
| Stray Inductance                   | $L_{\text{Stray}}$ |      | 11.1 |      | nH                      | Between DC- and DC+, f = 10 MHz                           |  |
| Case Temperature                   | $T_C$              | -40  |      | 125  | °C                      |   |  |
| Mounting Torque                    | $M_s$              | 4    | 5    | 5.5  | $\text{N}\cdot\text{m}$ | Baseplate, M6-1.0 Bolts                                   |  |
|                                    |                    | 4    | 5    | 5.5  |                         | Power Terminals, M6-1.0 Bolts                             |  |
| Weight                             | $W$                |      | 300  |      | g                       |   |  |
| Case Isolation Voltage             | $V_{\text{isol}}$  | 5    |      |      | kV                      | AC, 50 Hz, 1 minute                                       |  |
| Clearance Distance                 |                    | 9    |      |      | $\text{mm}$             | Terminal to Terminal                                      |  |
|                                    |                    | 30   |      |      |                         | Terminal to Baseplate                                     |  |
| Creepage Distance                  |                    | 30   |      |      |                         | Terminal to Terminal                                      |  |
|                                    |                    | 40   |      |      |                         | Terminal to Baseplate                                     |  |

Note (6): Total Effective Resistance (Per Switch Position) = MOSFET  $R_{DS(\text{on})}$  + Switch Position Package Resistance

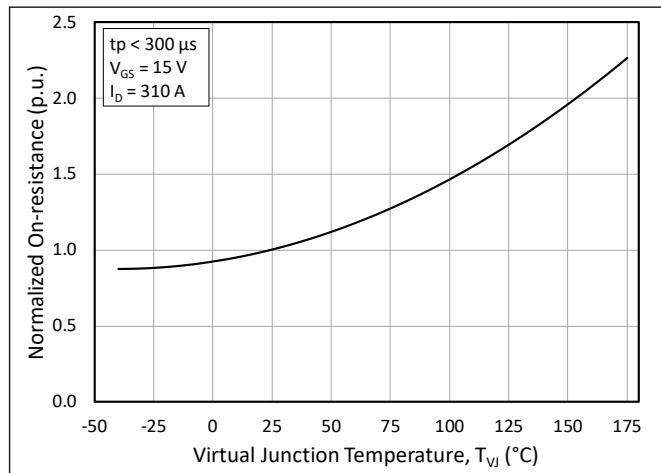
## Typical Performance



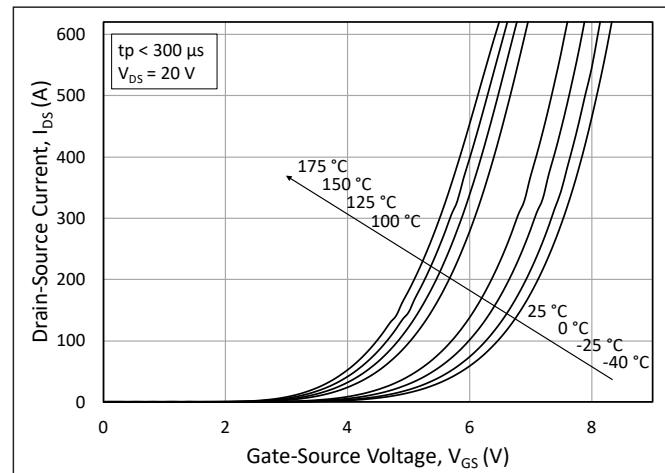
**Figure 1.** Output Characteristics for Various Junction Temperatures



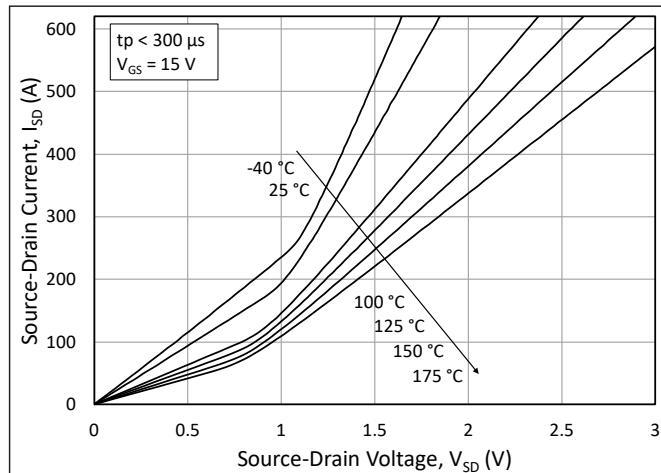
**Figure 2.** Normalized On-State Resistance vs. Drain Current for Various Junction Temperatures



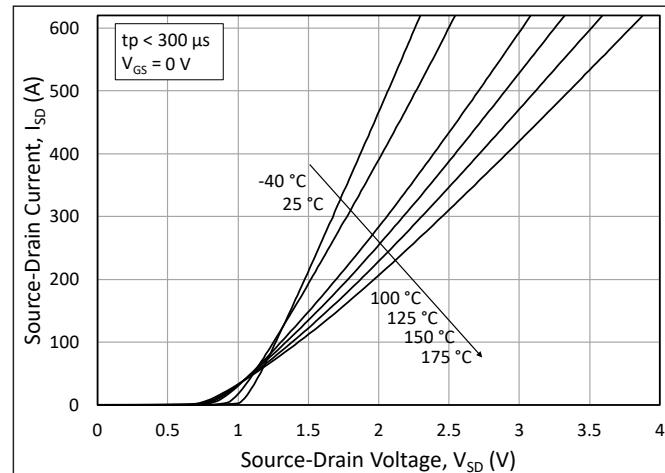
**Figure 3.** Normalized On-State Resistance vs. Junction Temperature



**Figure 4.** Transfer Characteristic for Various Junction Temperatures

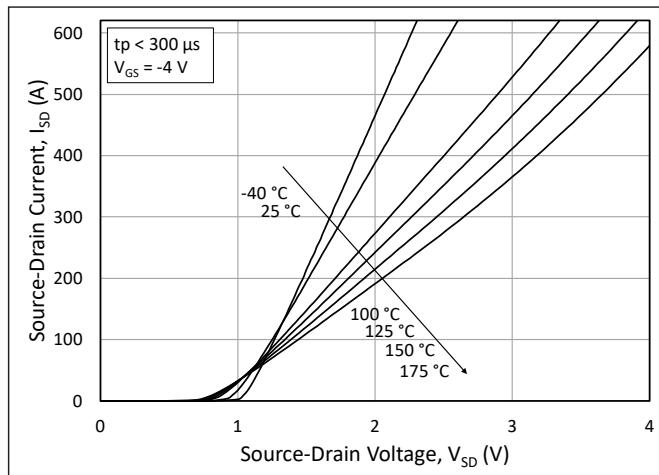


**Figure 5.** 3<sup>rd</sup> Quadrant Characteristic vs. Junction Temperatures at  $V_{GS} = 15$  V

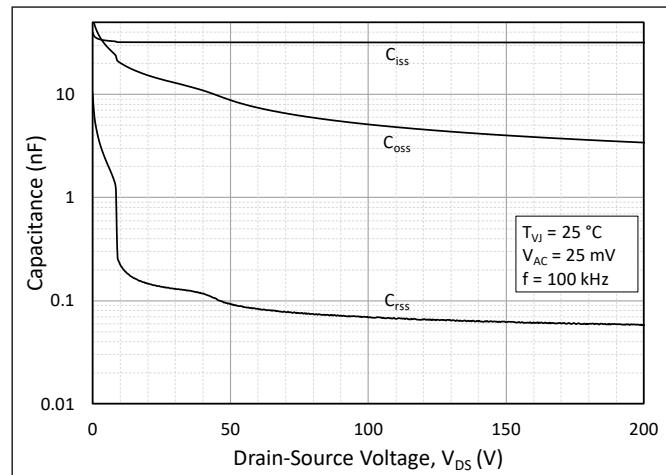


**Figure 6.** 3<sup>rd</sup> Quadrant Characteristic vs. Junction Temperatures at  $V_{GS} = 0$  V (Diode)

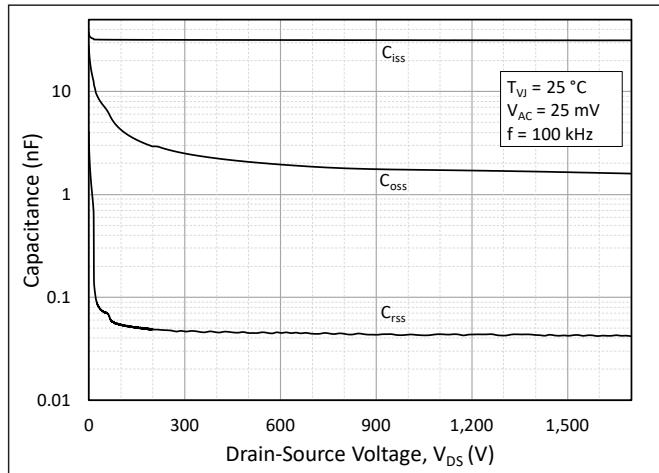
## Typical Performance



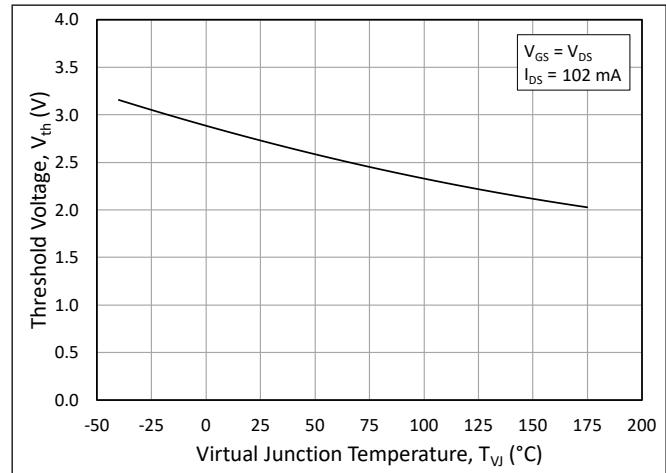
**Figure 7.** 3<sup>rd</sup> Quadrant Characteristic vs. Junction Temperatures at  $V_{GS} = -4$  V (Diode)



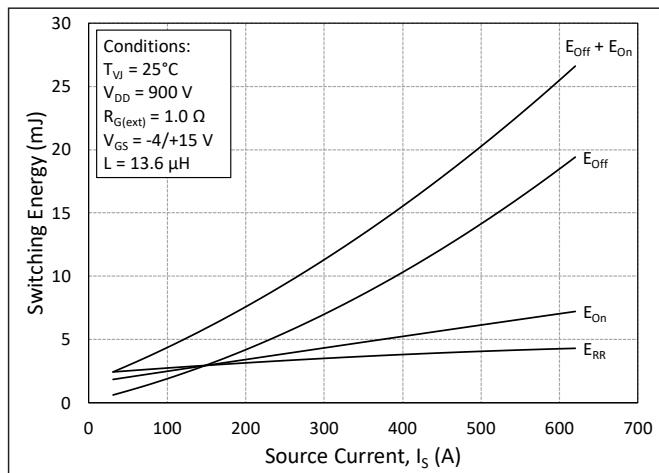
**Figure 8.** Typical Capacitances vs. Drain to Source Voltage (0 - 200 V)



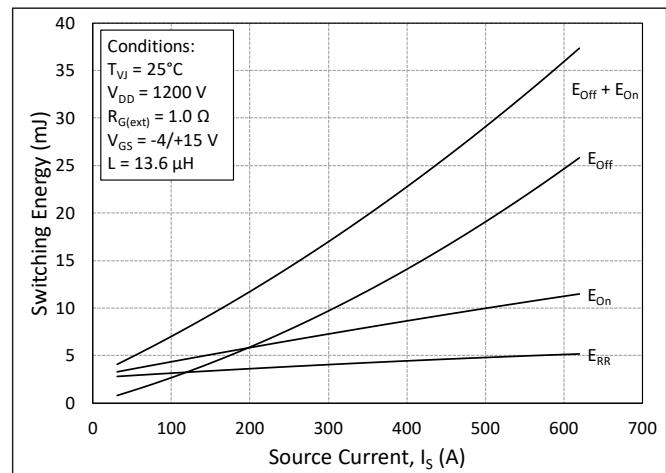
**Figure 9.** Typical Capacitances vs. Drain to Source Voltage (0 - 1700 V)



**Figure 10.** Threshold Voltage vs. Junction Temperature

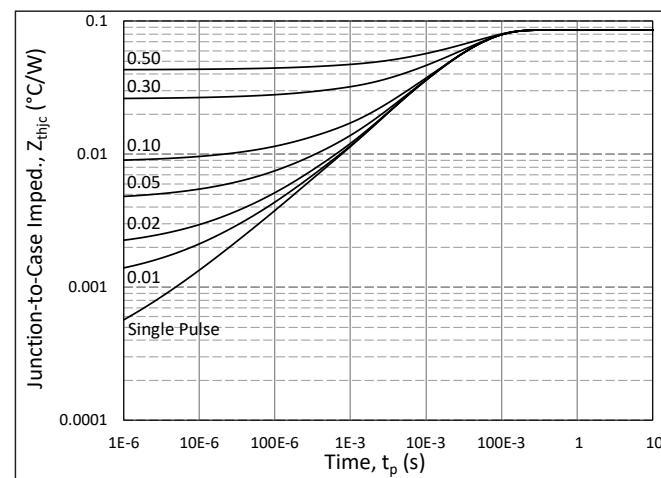
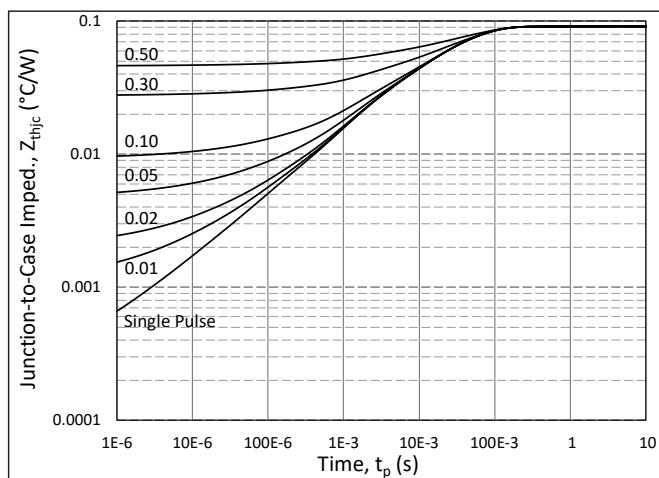
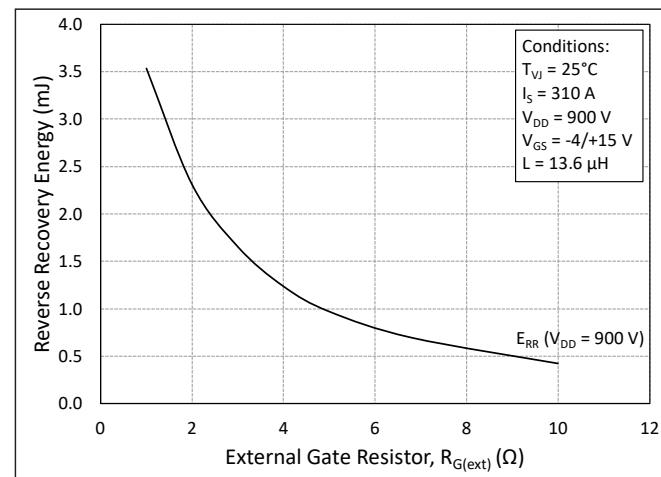
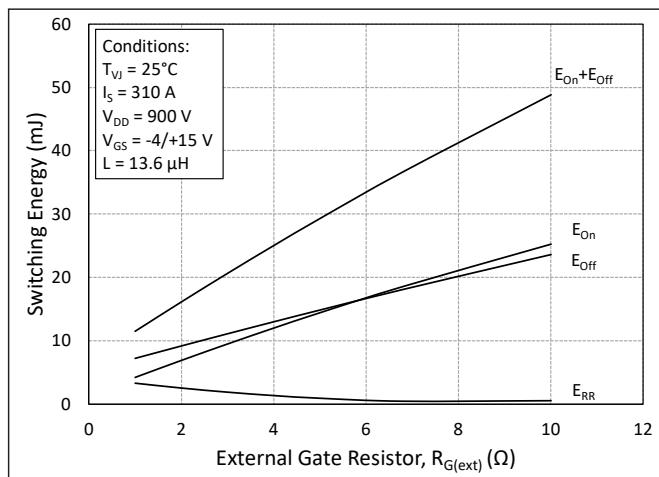
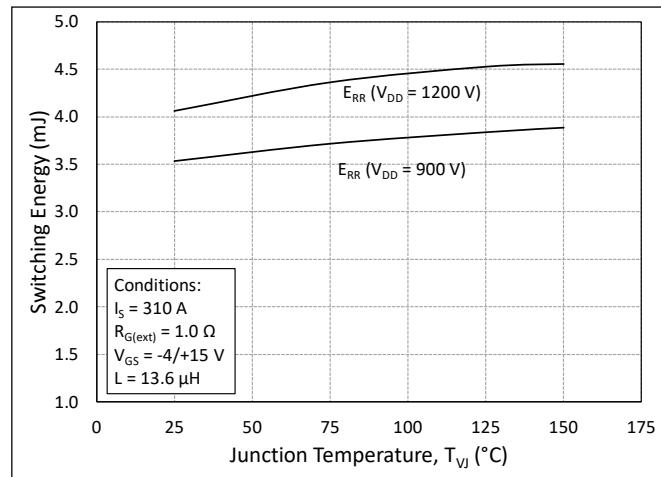
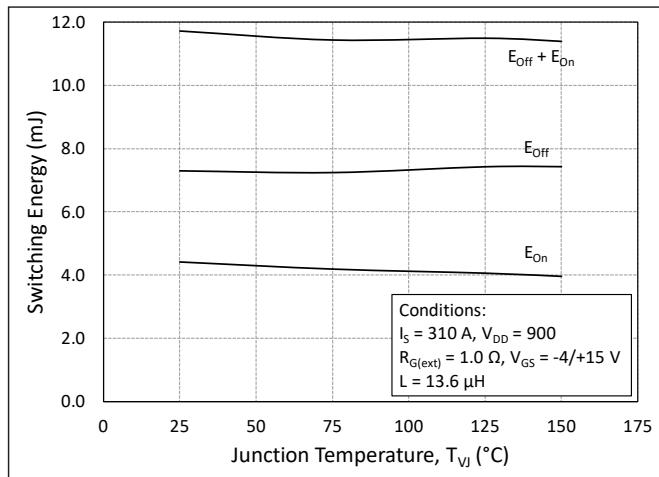


**Figure 11.** Switching Energy vs. Drain Current ( $V_{DD} = 900$  V)



**Figure 12.** Switching Energy vs. Drain Current ( $V_{DD} = 1200$  V)

## Typical Performance



## Typical Performance

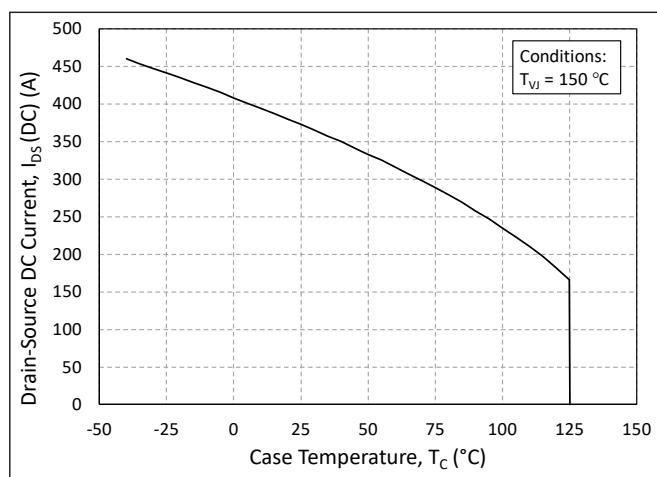
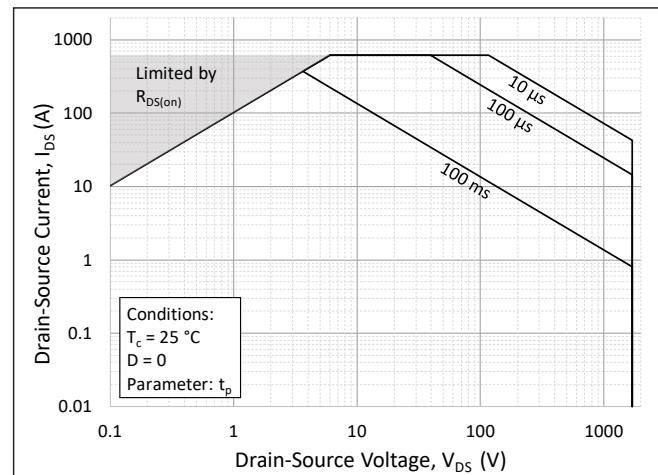
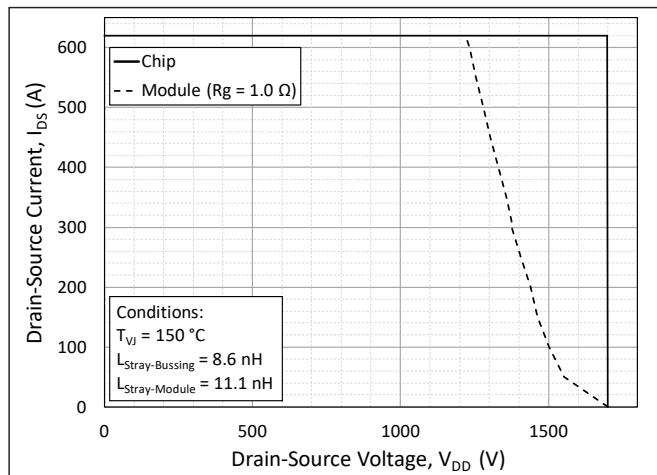


Figure 21. Continuous Drain Current Derating vs. Case Temperature

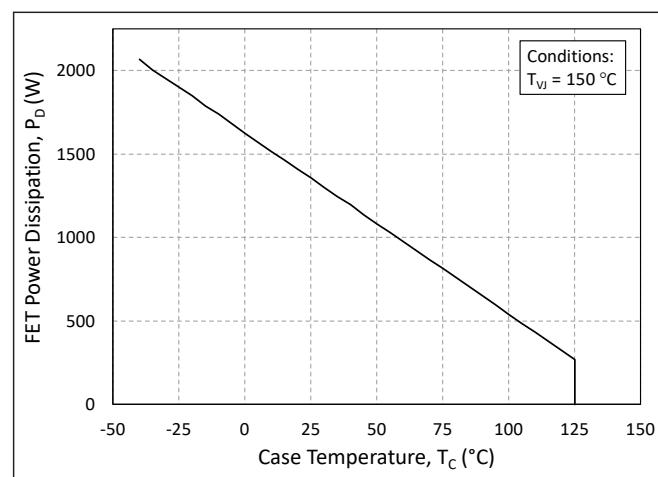


Figure 22. Maximum Power Dissipation Derating vs. Case Temperature

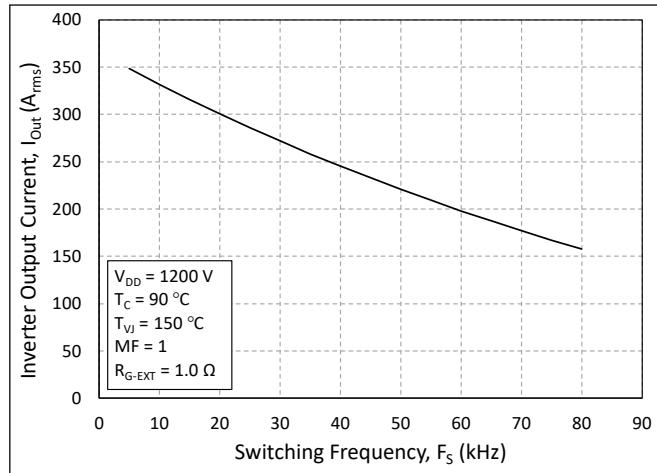
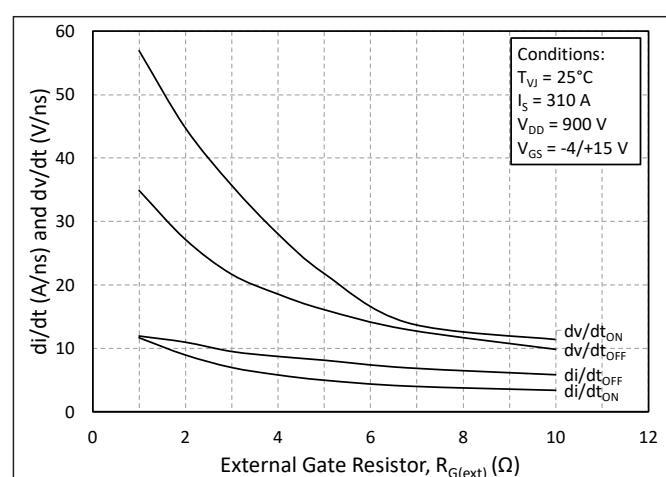
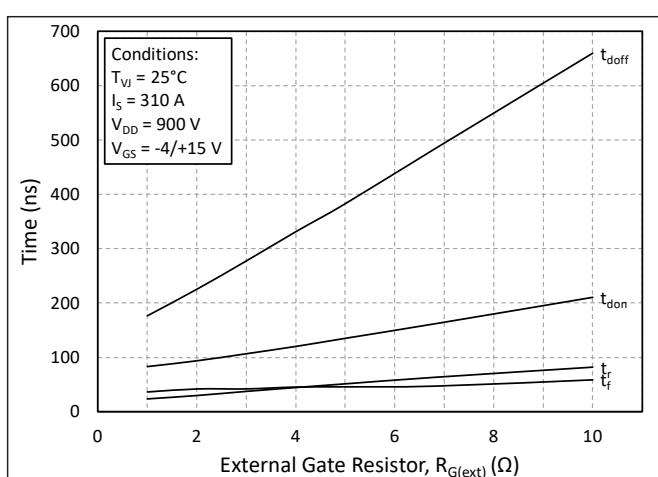
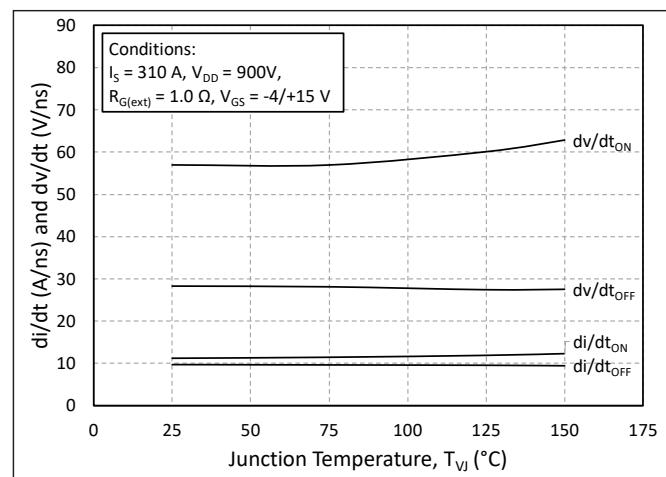
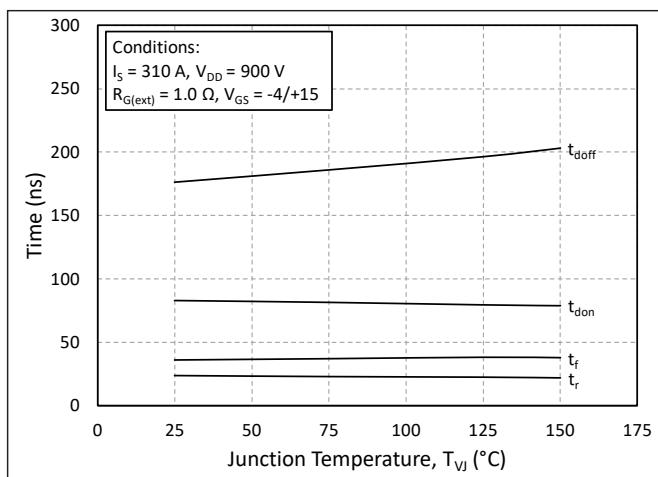
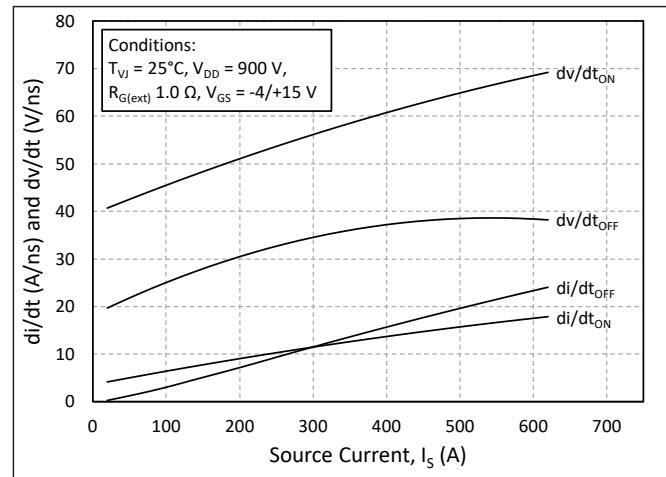
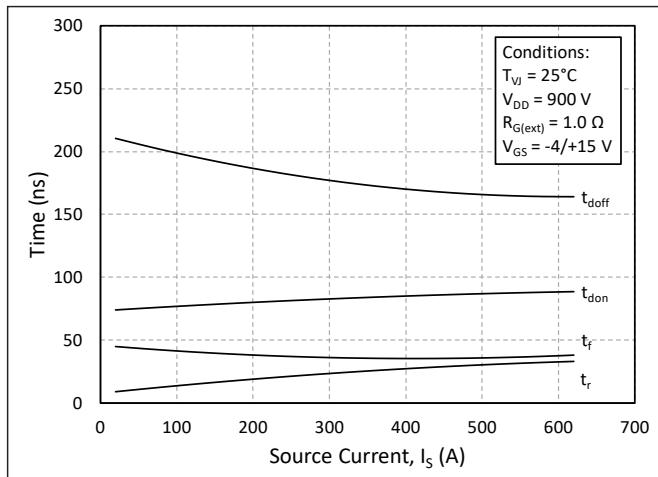


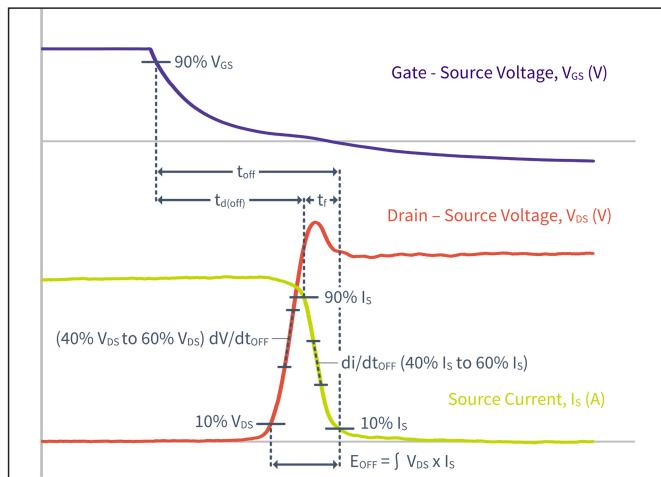
Figure 23. Typical Output Current Capability vs. Switching Frequency (Inverter Application)

## Timing Characteristics

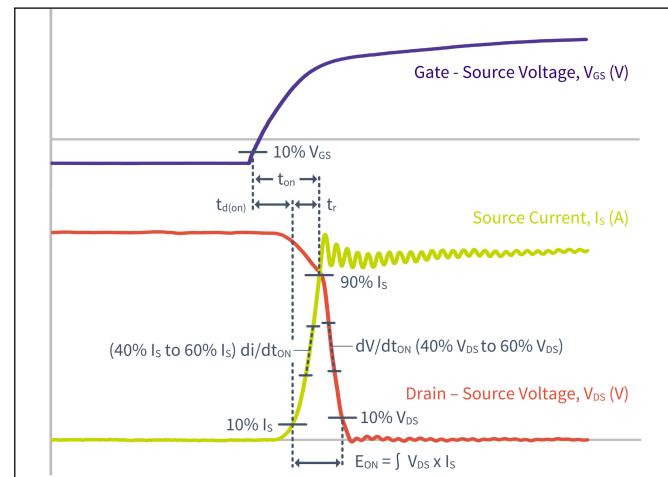




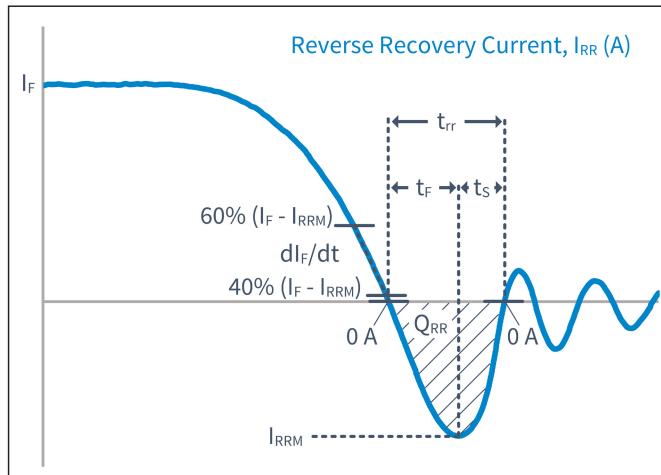
## Definitions



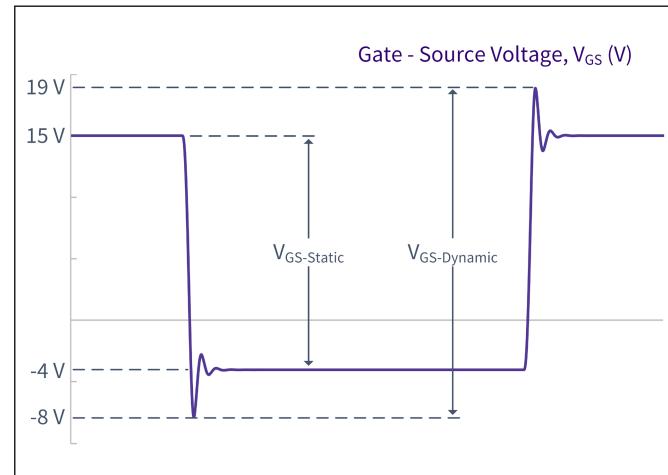
**Figure 30.** Turn-Off Transient Definitions



**Figure 31.** Turn-On Transient Definitions

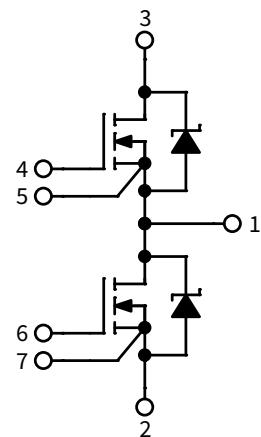
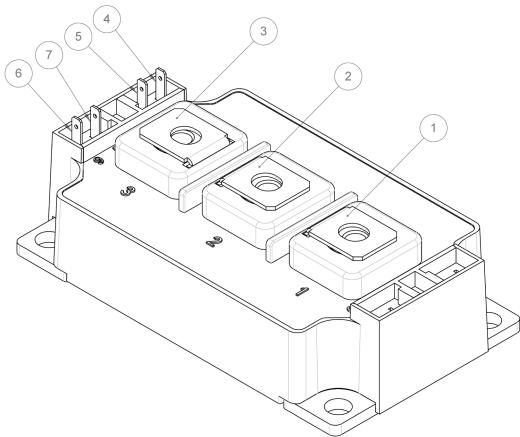


**Figure 32.** Reverse Recovery Definitions

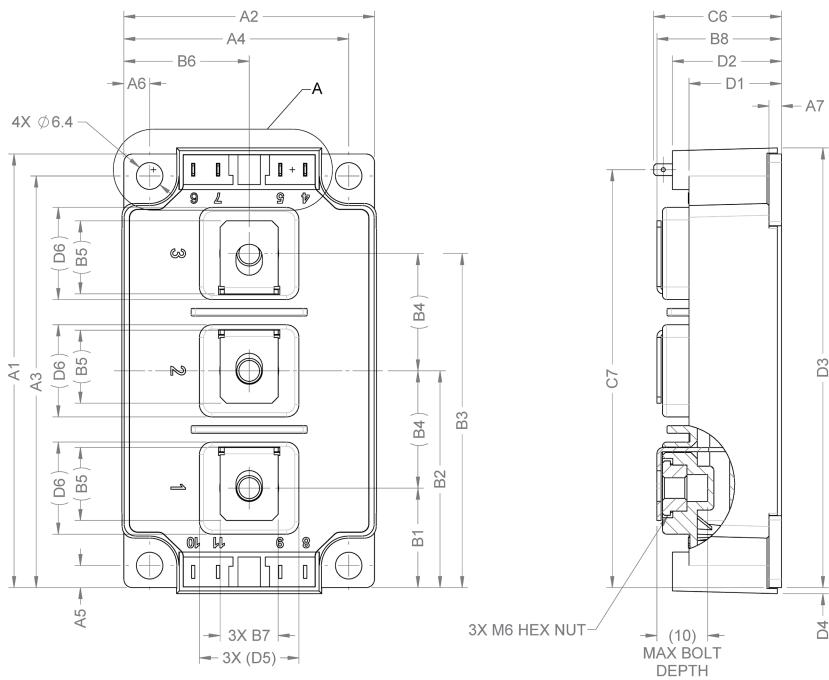


**Figure 33.** VGS Transient Definitions

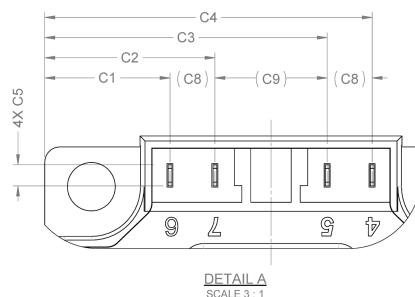
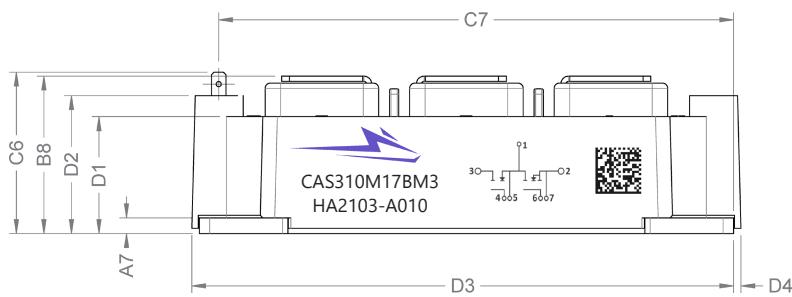
## Schematic and Pin Out



## Package Dimension (mm)



| DIMENSION TABLE |           |            |
|-----------------|-----------|------------|
| SYMBOL          | DIMENSION | TOLERANCE  |
| A1              | 103.5     | $\pm 0.30$ |
| A2              | 60.44     | $\pm 0.30$ |
| A3              | 98.25     | $\pm 0.30$ |
| A4              | 54.22     | $\pm 0.30$ |
| A5              | 5.25      | $\pm 0.30$ |
| A6              | 6.22      | $\pm 0.30$ |
| A7              | 3         | $\pm 0.30$ |
| B1              | 23.75     | $\pm 0.40$ |
| B2              | 51.75     | $\pm 0.40$ |
| B3              | 79.75     | $\pm 0.40$ |
| B4              | (28)      | REF.       |
| B5              | (17.43)   | REF.       |
| B6              | 30.23     | $\pm 0.40$ |
| B7              | (14)      | REF.       |
| B8              | 30.03     | $\pm 0.40$ |
| C1              | 16.73     | $\pm 0.40$ |
| C2              | 22.73     | $\pm 0.40$ |
| C3              | 37.73     | $\pm 0.40$ |
| C4              | 43.73     | $\pm 0.40$ |
| C5              | 2.8       | $\pm 0.40$ |
| C6              | 30.8      | $\pm 0.50$ |
| C7              | 99.75     | $\pm 0.40$ |
| C8              | (6)       | REF.       |
| C9              | (15)      | REF.       |
| D1              | 22.3      | $\pm 0.30$ |
| D2              | 26.3      | $\pm 0.30$ |
| D3              | 104.95    | $\pm 0.30$ |
| D4              | 1.45      | $\pm 0.40$ |
| D5              | (24)      | REF.       |
| D6              | (22)      | REF.       |





## Supporting Links & Tools

### Simulation Tools & Support

- [PLECS Models](#)
- [LTSpice Models](#)
- [SpeedFit 2.0 Design Simulator™](#)
- [Technical Support Forum](#)

### Comptable Evaluation Hardware

- [CGD1700HB2P-BM3: Evaluation Gate Driver Tool Optimized for the 1700 V BM3 Power Modules](#)
- [KIT-CRD-CIL17N-BM: Dynamic Characterization Evaluation Tool Optimized for 1700 V BM Power Modules](#)
- [CGD12HB00D: Differential Transceiver Daughter Board Companion Tool for Differential Gate Drivers](#)

### Application Notes

- [PRD-07933: Wolfspeed Power Module Thermal Interface Material Application User Guide](#)
- [PRD-06379: Environmental Considerations for Power Electronics](#)
- [PRD-08710: Measuring Stray Inductance in Power Electronic Systems](#)
- [PRD-07845: Power Module Baseplate Capacitance and Electromagnetic Compatibility](#)
- [PRD-08376: Thermal Characterization Methods and Applications](#)
- [PRD-06933: Capacitance Ratio and Parasitic Turn-On](#)

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